

**SANYO**

No. 4333A

**LC8902, 8902Q****Digital Audio Interface Receiver****Overview**

The LC8902 and LC8902Q are receiver LSIs for applications in which data is transmitted between digital audio equipment in the EIAJ format. These LSIs synchronize with the input signal and demodulate that signal to a regular format signal.

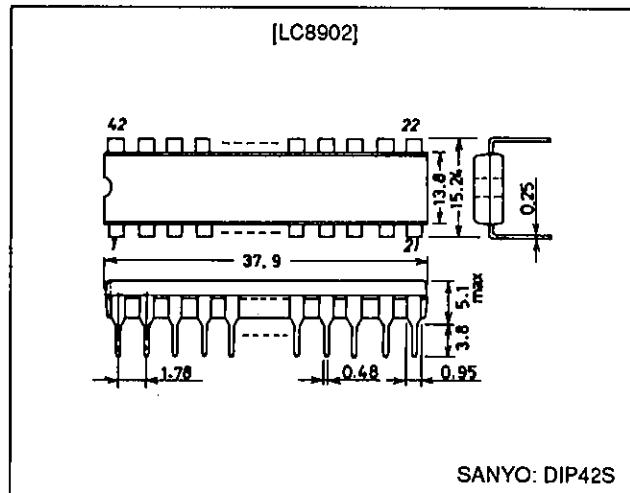
**Features**

- Built-in PLL circuit synchronizes with the input EIAJ format signal.
- Microcomputer interface receives mode settings and outputs fs codes, copy information, and category codes.
- Supports both 384 fs and 512 fs system clocks (selectable) and provides 256 fs, 128 fs, BCLK and LRCK clock outputs.
- Can operate in either digital source mode or analog source mode.
- User bit CD subcode interface
- DIP42S and QIP44M packages
- Si gate CMOS process, single 5 V power supply

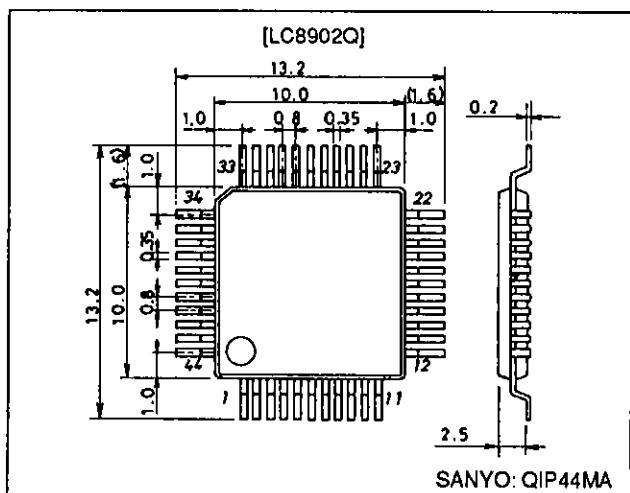
**Package Dimensions**

unit: mm

3025B-DIP42S



3148-QIP44MA

**SANYO Electric Co., Ltd. Semiconductor Business Headquarters**

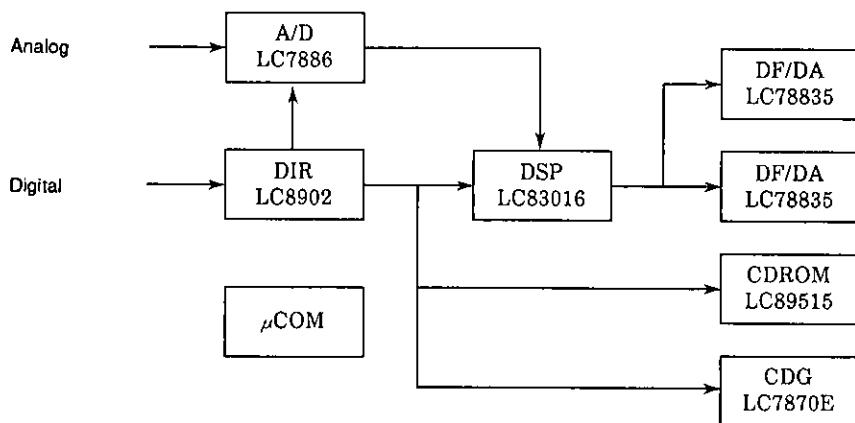
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## Application Usage Overview Diagram

When both digital source mode and analog source mode are used

Digital source mode: EIAJ CP-1201 format data reception mode

Analog source mode: Analog data is received and converted to digital for signal processing.



This figure shows an example of a structure using the LC8902/Q. In analog source mode the only function of the LC8902/Q is to provide control clocks.

## Pin Assignments

LC8902 (DIP42S)

DIN1	1	42	DVDD
DIN2	2	41	CL
DIN3	3	40	CE
DIN4	4	39	DI
DGND	5	38	DO
DIN5	6	37	EMPHA
DOUT1	7	36	LRCK
DOUT2	8	35	DATAOUT
RC1	9	34	BCLK
RC2	10	33	SUB2
CLKMD	11	32	SUB1
CLK	12	31	ERROR
TEST1	13	30	CLKOUT2
TEST2	14	29	CLKOUT1
XMODE	15	28	XOUT
AVDD	16	27	XIN
R	17	26	DVDD
AGND	18	25	SBCK
VIN	19	24	SFSY
VCO	20	23	PW
DGND	21	22	SFSY

Top View

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LC8902Q (QIP44M)

EMPHA	34	DATAOUT	22	DVDD
DO	35	BCLK	21	SBCK
DI	35	SUB2	20	SFSY
CE	37	SUB1	19	PW
CL	38	DGND	18	SFSY
DVDD	39	CLKOUT2	17	DGND
DIN1	40	CLKOUT1	16	VCO
DIN2	41	XOUT	15	VIN
DIN3	42	XIN	14	AGND
DIN4	43		13	R
DGND	44		12	AVDD
	1		11	
DIN5	2	DOUT1	10	
DOUT2	3	DOUT2	9	
RC1	4	RC1	8	
RC2	5	RC2	7	
CLKMD	6	CLKMD	6	
CLK	7	CLK	5	
TEST1	8	TEST1	4	
TEST2	9	TEST2	3	
XMODE	10	XMODE	2	
AVDD	11	AVDD	1	

Top View

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## Specifications

### Absolute Maximum Ratings at Ta = 25°C

Parameter	Symbol	Conditions	Ratings	Unit
Maximum supply voltage	V <sub>DD</sub> max		-0.3 to +7.0	V
Maximum I/O voltages	V <sub>I</sub> , V <sub>O</sub> max		-0.3 to V <sub>DD</sub> + 0.3	V
Operating temperature	T <sub>opr</sub>		-30 to +75	°C
Storage temperature	T <sub>stg</sub>		-55 to +125	°C

**Allowable Operating Ranges**

Parameter	Symbol	Conditions	min	typ	max	Unit
Supply voltage	V <sub>DD</sub>		4.5	5.0	5.5	V
Operating temperature	T <sub>opg</sub>		-30		+75	°C

**DC Characteristics at Ta = -30 to +75°C, V<sub>DD</sub> = 4.5 to 5.5 V**

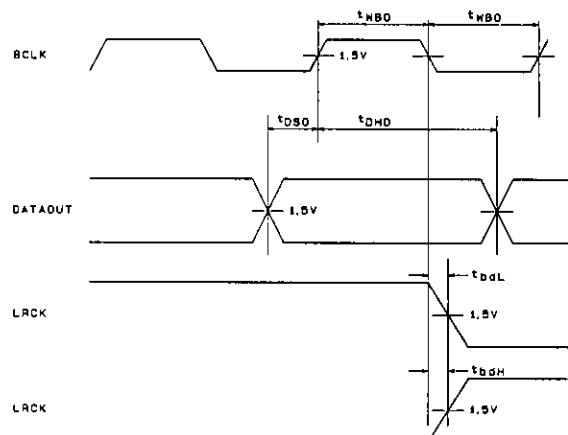
Parameter	Symbol	Conditions	min	typ	max	Unit
Input high level voltage	V <sub>IH1</sub>	*1	2.2		V <sub>DD</sub> + 0.3	V
Input low level voltage	V <sub>IL1</sub>	*1	-0.3		+0.8	V
Input high level voltage	V <sub>IH2</sub>	*2	0.7 V <sub>DD</sub>		V <sub>DD</sub> + 0.3	V
Input low level voltage	V <sub>IL2</sub>	*2	-0.3		+0.3 V <sub>DD</sub>	V
Input high level voltage	V <sub>IH3</sub>	*3	0.8 V <sub>DD</sub>		V <sub>DD</sub> + 0.3	V
Input low level voltage	V <sub>IL3</sub>	*3	-0.3		+0.2 V <sub>DD</sub>	V
Output high level voltage	V <sub>OH</sub>	t <sub>OH</sub> = -1 μA	V <sub>DD</sub> - 0.05			V
Output low level voltage	V <sub>OL</sub>	t <sub>OL</sub> = 1 μA			V <sub>SS</sub> + 0.05	V
Current drain	I <sub>DD</sub>	*4	10	20	30	mA
Input amplitude	V <sub>PP</sub>	*5	0.4		V <sub>DD</sub> + 0.3	V

- Note:
1. Input pins other than data input pins DIN1, DIN2, DIN3, DIN4 and XMODE. TTL compatible.
  2. The XIN pin. CMOS compatible.
  3. The XMODE and RC1 pins. CMOS Schmitt inputs.
  4. At Ta = 25°C, V<sub>DD</sub> = 5.0 V, and for an input data fs of 48 kHz.
  5. The condition prior to the capacitors on the DIN1, DIN2, DIN3 and DIN4 input pins.

**AC Characteristics at Ta = -30 to +75°C, V<sub>DD</sub> = 4.5 to 5.5 V**

Parameter	Symbol	Conditions	min	typ	max	Unit
Output pulse width	t <sub>WBO</sub>	*6	160			ns
Output setup time	t <sub>DSO</sub>		80			ns
Output data hold time	t <sub>DHO</sub>		80			ns
Output delay (high)	t <sub>bDH</sub>		-10	0	+10	ns
Output delay (low)	t <sub>bDL</sub>		-10	0	+10	ns

- Note: 6. For an input data fs of 48 kHz, with a 30 pF load capacitance on each pin.

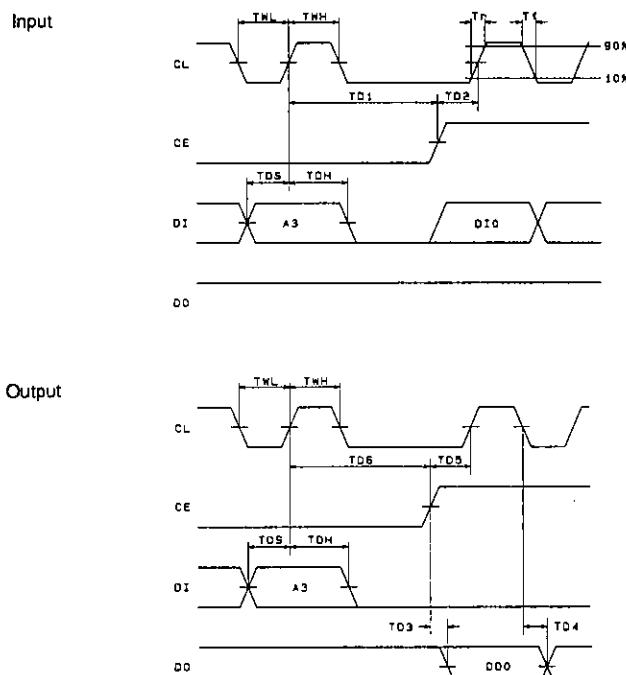


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# LC8902, 8902Q

## Microcomputer Interface Block AC Characteristics at $T_a = -30$ to $+75^\circ\text{C}$ , $V_{DD} = 4.5$ to $5.5$ V

Parameter	Symbol	Conditions	min	typ	max	Unit
CL low level pulse width	TWL		100			ns
CL high level pulse width	TWH		100			ns
Data setup time	TDS		50			ns
Data hold time	TDH		50			ns
CL rise time	Tr	CL, CE, DI			30	ns
CL fall time	Tf	CL, CE, DI			30	ns
CE delay time	TD1		1.0			μs
CL delay time	TD2		50			ns
Data delay time	TD3	With a 30 pF load capacitance			25	ns
CL, data delay time	TD4	With a 30 pF load capacitance			50	ns
CL delay time	TD5		100			ns
CL, CE delay time	TD6		1.0			μs

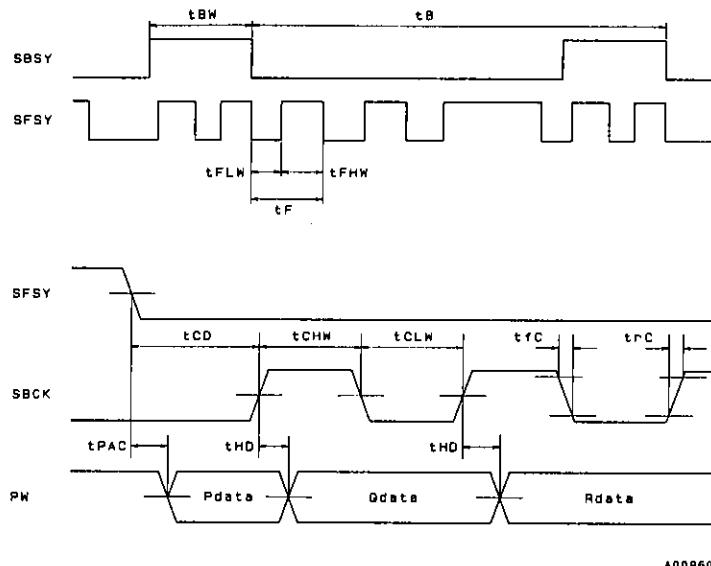


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## CD Subcode Interface Block AC Characteristics at $T_a = -30$ to $+75^\circ\text{C}$ , $V_{DD} = 4.5$ to $5.5$ V

Parameter	Symbol	Conditions	min	typ	max	Unit	
SBSY block frequency	tB		12.0	13.3	14.7	ms	
SBSY pulse width	tBW	*7	110			μs	
SFSY frame frequency	tF	*8	90	136	165	μs	
SFSY high level pulse width	tFW		4			μs	
SFSY low level pulse width	tFLW		1.5			μs	
SBCK high level pulse width	tCHW	*9	2.0	4.0	5.0	μs	
SBCK low level pulse width	tCLW	*9	2.0	4.0	5.0	μs	
SBCK rise time	trC				30	ns	
SBCK fall time	tfC				30	ns	
SBCK delay time	tCD	*9	10	20	30	μs	
P data access	tPAC				3	10	μs
Data hold time	tHD		0			μs	

Note: Assumes that the load capacitance on each output pin is 30 pF.



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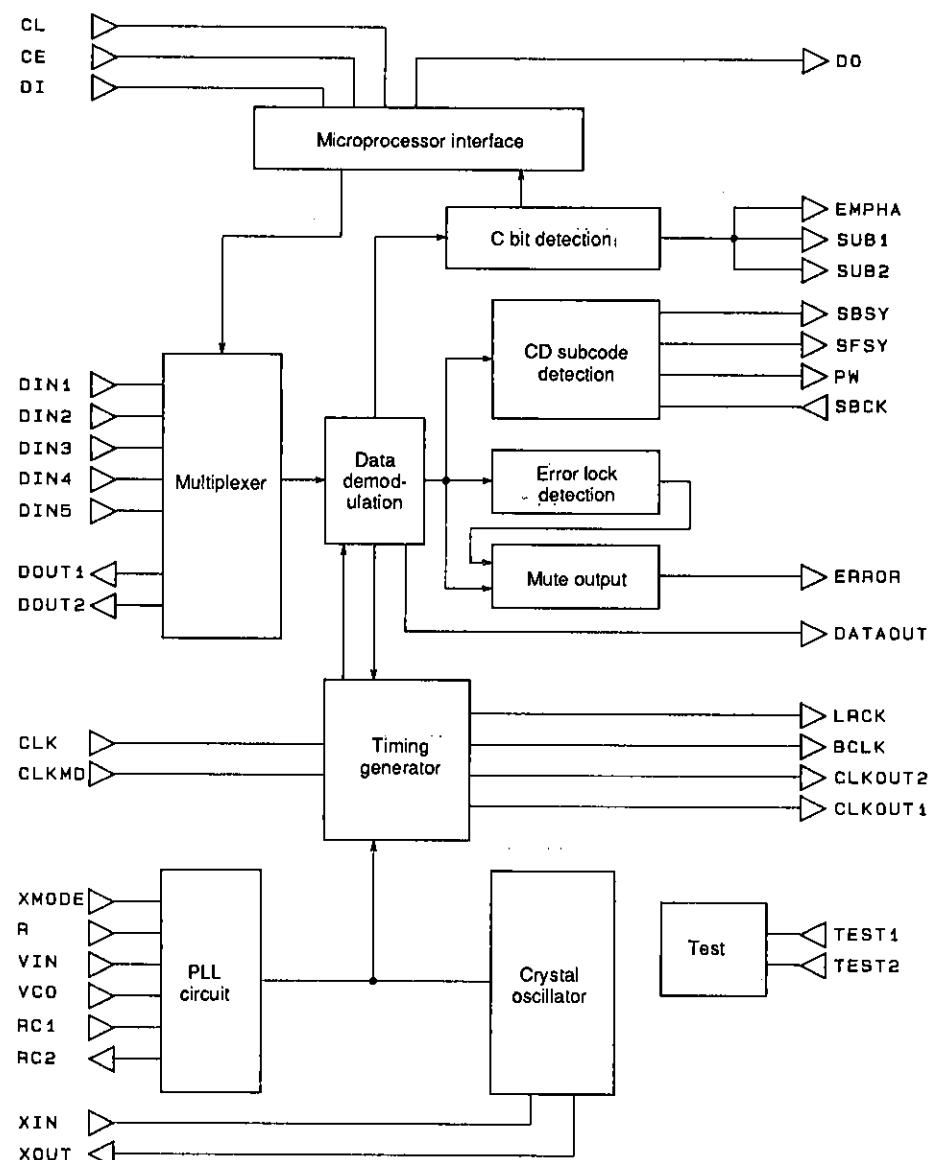
The LC8902/Q uses the subcode synchronization word and the start bit in the user bits for subcode interface system timing extraction. Therefore, SBSY and SF SY change depending on that timing. Keep the following notes on user bit transfer in mind when using the values of tBW, tF, tCHW and tCD within the specifications described above. Basically, user bit transfers must follow the table shown here.

	1	2	3	4	5	6	7	8	9	10	11	12	
S0	0	0	0	0	0	0	0	0	0	0	0	0	Subcode sync word*7,8
S1	0	0	0	0	0	0	0	0	0	0	0	0	
S2	1	Q2	R2	S2	T2	U2	V2	W2	0	0	0	0	
S3	1	Q3	R3	S3	T3	U3	V3	W3	0	0	0	0	
:	:	:	:	:	:	:	:	:	:	:	:	:	
S97	1	Q97	R97	S97	T97	U97	V97	W97	0	0	0	0	Subcode sync word*7,8
S0	0	0	0	0	0	0	0	0	0	0	0	0	
S1	0	0	0	0	0	0	0	0	0	0	0	0	
S2	1	Q2	R2	S2	T2	U2	V2	W2	0	0	0	0	Word length*8,9
:	:	:	:	:	:	:	:	:	:	:	:	:	

- Note:
7. Subcode synchronization is taken as a block synchronization section (the start of a block) when a minimum of 22 consecutive data bits are zero.
  8. The frame sync signal S0 period is 90.7 µs. The S1 period also has a minimum value of 90.7 µs (when there are 22 consecutive zero data bits), depending on the subcode sync word period.
  9. When the shortest user data word length is used, the SBCK signal delay (tHD) and pulse widths (tCHW and tCLW) must be set at or below their typical values.

**Pin Functions**

Pin No.		Symbol	I/O	Function
QIP	DIP			
1	6	DIN5	I	Data input. There is no built-in amplifier on this pin.
2	7	DOUT1	O	
3	8	DOUT2	O	Data outputs
4	9	RC1	I	RC oscillator input This circuit generates a clock used to detect incorrect PLL locking and to reset the PLL system.
5	10	RC2	O	RC oscillator output This pin outputs a clock with a frequency of about 40 kHz when the component values specified in the sample application circuit are used.
6	11	CLKMD	I	CLKOUT2 output clock switching: Low = 256 fs, high = 128 fs
7	12	CLK	I	Clock mode switching: Low = 384 fs, high = 512 fs
8	13	TEST1	I	
9	14	TEST2	I	Test pin (Should be tied low in normal operation.)
10	15	XMODE	I	Used to start system operation after power is applied.
11	—	DV <sub>DD</sub>		Digital power supply
12	16	AV <sub>DD</sub>		Analog power supply
13	17	R	I	VCO oscillator band adjustment
14	18	AGND		Analog ground
15	19	VIN	I	VCO free-running setting
16	20	VCO	O	PLL low-pass filter
17	21	DGND		Digital ground
18	22	SBSY	O	Subcode interface block sync signal
19	23	PW	O	Subcode interface data output
20	24	SFSY	O	Subcode interface frame sync signal
21	25	SBCK	I	Subcode interface bit clock input
22	26	DV <sub>DD</sub>		Digital power supply
23	27	XIN	I	Crystal oscillator input
24	28	XOUT	O	Crystal oscillator output
25	29	CLK OUT1	O	Crystal oscillator and VCO clock output
26	30	CLK OUT2	O	256 fs and 128 fs clock output
27	31	ERROR	O	Error mute signal output
28	—	DGND		Digital ground
29	32	SUB1	O	
30	33	SUB2	O	Sampling frequency output
31	34	BCLK	O	Bit clock output
32	35	DATA OUT	O	Audio data output
33	36	LRCK	O	Left/right clock output (High = left, low = right)
34	37	EMPHA	O	High = emphasis on, low = emphasis off. Outputs a low level in analog mode.
35	38	DO	O	Microprocessor interface output
36	39	DI	I	Microprocessor interface input
37	40	CE	I	Microprocessor interface chip enable input
38	41	CL	I	Microprocessor interface clock input
39	42	DV <sub>DD</sub>		Digital power supply
40	1	DIN1	I	
41	2	DIN2	I	
42	3	DIN3	I	Data inputs with built-in amplifiers
43	4	DIN4	I	
44	5	DGND		Digital ground

**Block Diagram**

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**Clock Modes**

The LC8902/Q CLKOUT1 and CLKOUT2 output clock modes are selected by the CLK and CLKMD pins according to the table.

CLK	CLK OUT1
L	384 fs clock output
H	512 fs clock output

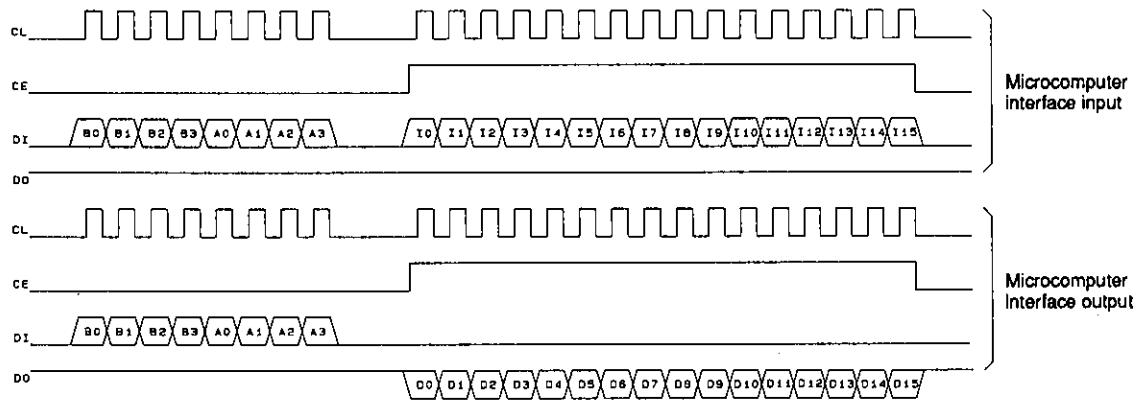
CLK MD	CLK OUT2
L	256 fs clock output*
H	128 fs clock output

Note: \* When the CLK pin is low, the 256 fs clock duty has a high to low ratio of 2:1.

## Microcomputer Interface

The microcomputer interface is used for specifying the data input pin, for setting the output data format, and for specifying subcode output, system stop, and analog source mode. The figure shows the interface I/O formats.

### Microcomputer Interface Formats



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### Address

The bits B0 to A3 in the format figure are the address. There are two addresses allocated to the LC8902/Q, one for input and one for output. The microprocessor must specify the input address to input data and the output address to output data.

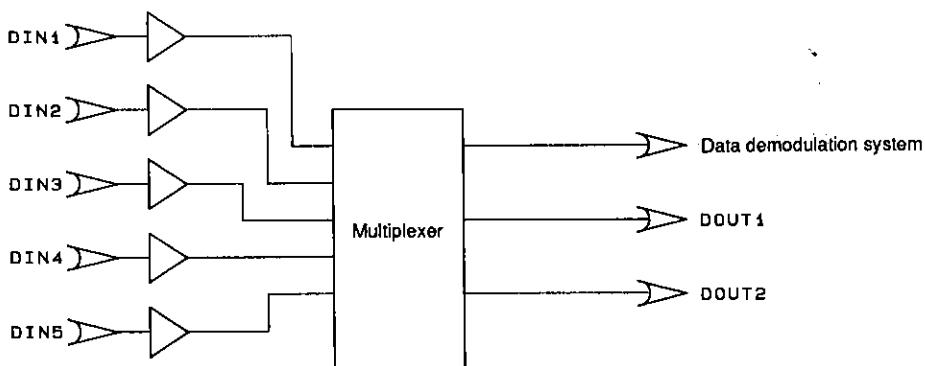
### Address Code

Mode	B0	B1	B2	B3	A0	A1	A2	A3
Data input	H	L	H	L	L	H	H	L
Data output	L	H	H	L	L	H	H	L

### Microcomputer Interface Input

#### 1. Input pin settings

The DIN1 to DIN4 data input pins have built-in amplifiers and can accept signals with levels of about 400 mVp-p. DIN5 is a special-purpose input pin for optical input.



Data input system

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The data input system multiplexer is controlled by inputs from the microcomputer interface. The table shows the relationship between the code in bits I5 to I13 in the microcomputer interface format and the data demodulation outputs DOUT1 and DOUT2.

I5	L	H	L	H	L	H	L	H
I6	L	L	H	H	L	L	H	H
I7	L	L	L	L	H	H	H	H
Data demodulation input	DIN1	DIN2	DIN3	DIN4	DIN5	XSYS	XSYS	XSYS

I8	L	H	L	H	L	H	L	H
I9	L	L	H	H	L	L	H	H
I10	L	L	L	L	H	H	H	H
DOUT1	DIN1	DIN2	DIN3	DIN4	DIN5	GND	GND	GND

I11	L	H	L	H	L	H	L	H
I12	L	L	H	H	L	L	H	H
I13	L	L	L	L	H	H	H	H
DOUT2	DIN1	DIN2	DIN3	DIN4	DIN5	GND	GND	GND

Note: Setting the data demodulation input code to one of the XSYS settings switches the system clock from the VCO to the crystal oscillator and sets the LC8902/Q to analog source mode. Selecting one of the input pins once again sets the LC8902/Q to digital source mode and PLL operation.

## 2. Data output mode setting

There are two data output modes: 16-bit MSB first and 20-bit MSB first. These are selected by the bit I14 code.

I14	L	H
Data output mode	16-bit MSB first	20-bit MSB first

## 3. System stop

The operation of both the VCO and the crystal oscillator can be stopped, thus stopping the whole LC8902/Q system, by setting the bit I4 code as shown in the table.

I4	L	H
—	System operation	System stop

The values of the bits I4 to I14 are all initialized to low immediately after the XMODE pin goes from low to high. Since bits I0 to I3 and I15 are not used, their initial values are undefined.

## Microcomputer Interface Output

Bits D0 to D15 in the microcomputer interface output format have the following meanings.

Bit	Function
D0	Invalid bit. Always output as a low level.
D1	Indicates the sample frequency.
D2	Corresponds to the fs external output pin.
D3	Indicates the state of the copy flag. High = copy enabled, low = copy protect
D4	Outputs the first bit of the channel status bits.
D5 to D12	These pins output the channel status 8-bit category codes serially.
D13 to D15	Invalid bits. Always output as low levels.

### Interpretation of the D1 and D2 bits

Sampling frequency	32 kHz	44.1 kHz	48 kHz	#1
D1	H	L	L	H
D2	H	L	H	L

Note: 1. The "#1" value indicates either a PLL lock error or analog source mode. In these states the data is cleared and bits D0 and D3 to D15 are all set to low.  
 2. D1 and D2 are in the "#1" state in the initial values of the codes immediately after the XMODE pin goes from low to high. All other codes are set to low.  
 3. The interval between one microcomputer data read out operation and the next must be 6 ms or longer.

## FS Output Code

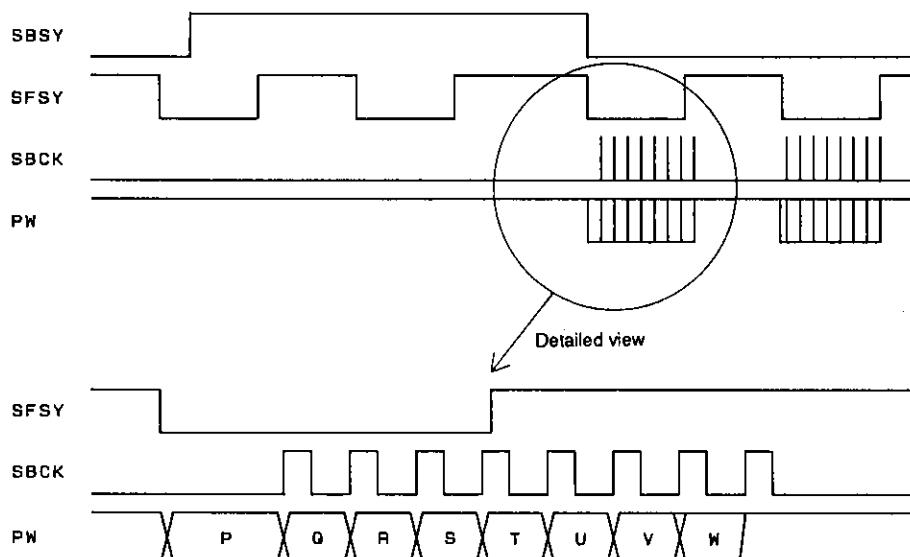
The SUB1 and SUB2 pins indicate the input data sampling frequency.

Sampling frequency	32 kHz	44.1 kHz	48 kHz	#1
SUB1	H	L	L	H
SUB2	H	L	H	L

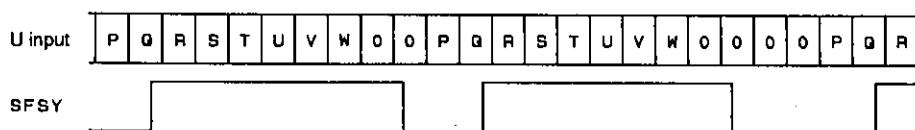
Note: The "#1" values indicates PLL lock error or analog source mode. When SUB1 and SUB2 have these values, the DATAOUT and EMPHA pins will output low levels.

## CD Subcode Interface

The LC8902/Q uses the SFSY, SBCK, PW and SBSY pins to output the CD subcode data. This data is the user bits that were transferred according to the CP-1201 interface format and converted to a format that conforms to the CP-2401 interface format. The timing is shown in the figures.



The timing of the rising and falling edges of the SFSY signal is changed according to the timing of the start bits in the input data user bits as shown in the figure.



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## Errors

1. **ERROR pin:** This pin goes high when there are errors in the input data or when the PLL circuit is unlocked. When data demodulation returns to normal, the high level is held for about 200 to 300 ms and then the ERROR pin goes low. This time is inversely proportional to the  $f_s$  of the input data.
2. **Data processing when an error occurs:** The table lists the data processing performed when an error occurs.

Error Type	Audio Output Data	FS Output Code
Up to 8 consecutive parity errors	Previous data value output	Retained
Nine or more consecutive parity errors	Data with the value zero is output.	Retained
PLL lock error	Data with the value zero is output.	Data is cleared and the "#1" state is indicated.

Note: Preamble detection is used to recognize PLL lock errors.

## Analog Source Mode

The LC8902/Q switches to analog source in the following two cases.

1. When analog source mode is selected by the data sent over the microcomputer interface
2. When there is no signal on the input pin selected for data demodulation

In analog source mode, the clock that runs the whole system is supplied by the crystal oscillator clock and the PLL circuit and data demodulation are stopped. The BCLK, LRCK, CLK, OUT1 and CLKOUT2 clocks are output.

The output pins function as follows in analog source mode.

- DOUT1, DOUT2  
Data specified through the microcomputer interface is output.
- ERROR  
The lock error state high level is output.
- SUB1, SUB2  
The "#1" lock error state code is output.
- DATAOUT  
The lock error state low level is output.
- EMPHA  
The lock error state low level is output.
- Microcomputer interface codes  
Input codes: The code values set through the microcomputer interface are retained.  
Output codes: Values identical to those for a PLL lock error are output.

## Crystal Oscillator

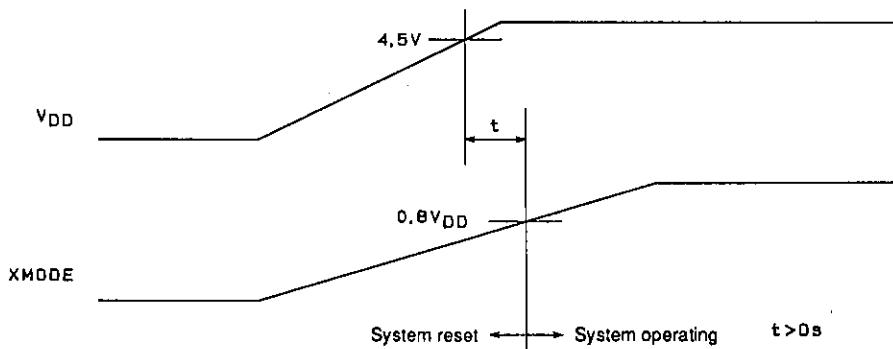
1. The presence or absence of data is determined by an internal detection circuit. This circuit operates on either the VCO or the crystal oscillator clock. When power is first applied, the clock is supplied from the VCO, and the LC8902/Q switches to the crystal oscillator if a no data state is detected. Here, if a clock signal was not supplied from the crystal oscillator after a no data state is detected, the whole system would stop and remain in the stopped state, since the detection circuit would not operate even if data were supplied.
2. The XIN and XOUT pins include a built-in oscillator amplifier circuit, and take on the following states when a crystal oscillator is connected.

Pin	Data Present*	Data Absent
XIN	High	Accepts crystal oscillator input.
XOUT	Low	Outputs the inverted state of the XIN pin.

Note: \* The XIN pin is pulled-up internally when the LC8902/Q is in the data present state.

**XMODE**

The XMODE pin resets the LC8902/Q system. The LC8902/Q will start to function normally if a high level is applied to this pin after the power supply voltage rises above a value of at least 4.5 V.



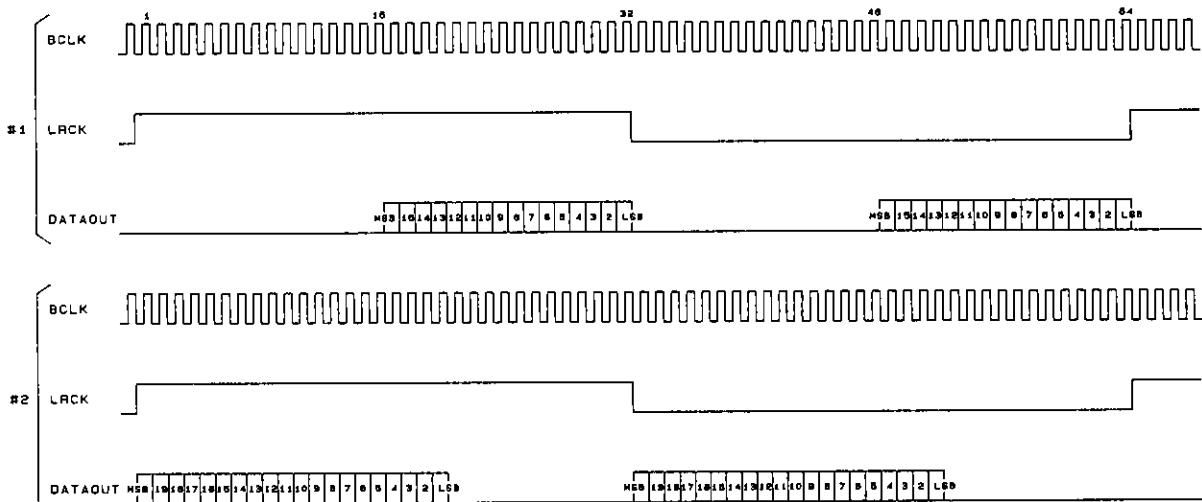
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1. Once the LC8902/Q is operating, the system will be reset if a low level is applied once again to the XMODE pin.
2. This IC can be used without using the microcomputer interface by tying the CE, CL and DI microcomputer interface input pins low and using D1 as the data input pin. This technique can be used as a simplified method for product evaluation.

**Data Output Timing**

The figures show the data output timing.

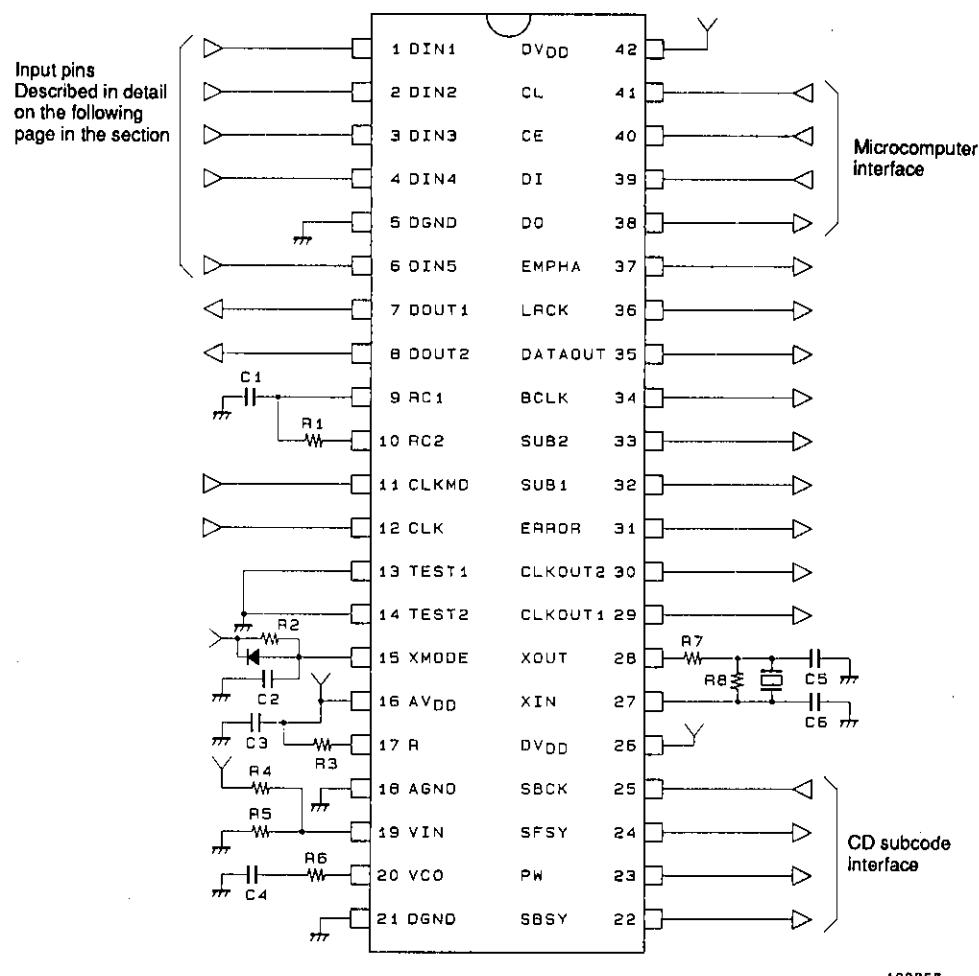
1. Data is output in synchronization with the falling edge of the BCLK signal.
2. Data, BCLK and LRCK are output in synchronization with the rising edge of the 256 fs clock.
3. The data output timings for 20-bit MSB first and 16-bit MSB first output are shown in the timing charts.

**Timing Chart**

Timing chart #1 is for 16-bit MSB first output mode.  
Timing chart #2 is for 20-bit MSB first output mode.

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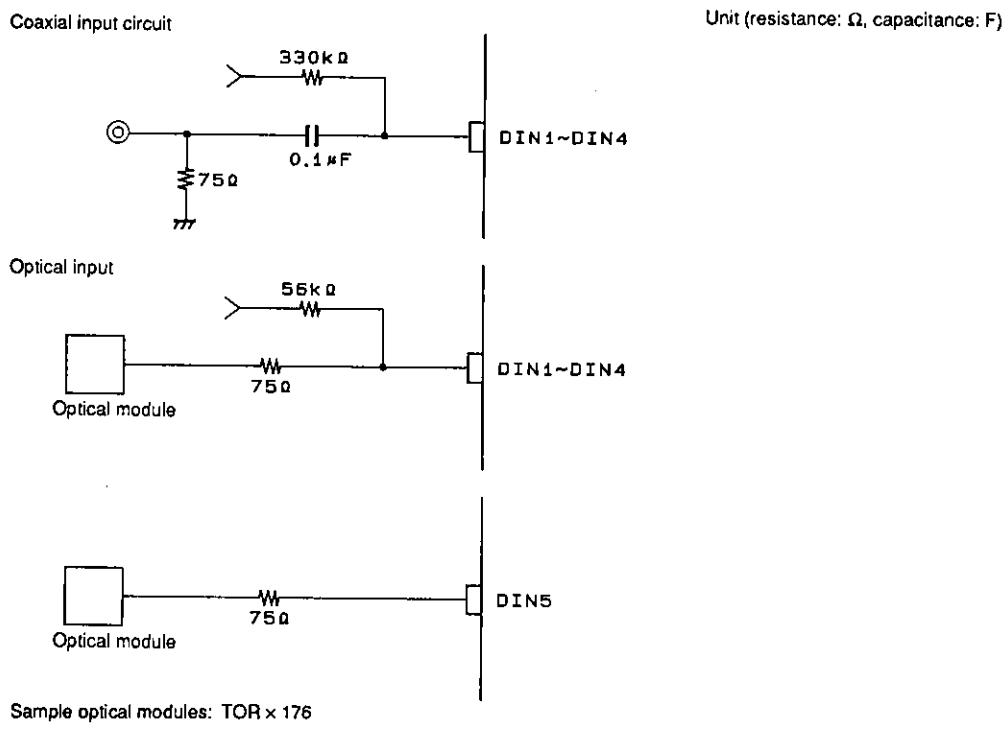
## Sample Application Circuit



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## Circuit Constants

Item	Symbol	Value	Item	Symbol	Value
Resistors	R1	33 kΩ	Capacitors	C1	1000 pF
	R2	10 kΩ		C2	10 to 100 μF
	R3	24 kΩ		C3	0.1 μF
	R4	5.6 kΩ		C4	0.01 μF
	R5	5.6 kΩ		C5	10 to 47 pF
	R6	120 to 150 Ω		C6	10 to 47 pF
	R7	200 Ω			
	R8	200 kΩ			

**Input Pin Application Circuits**

- No products described or contained herein are intended for use in surgical implants, life-support systems, aerospace equipment, nuclear power control systems, vehicles, disaster/crime-prevention equipment and the like, the failure of which may directly or indirectly cause injury, death or property loss.
- Anyone purchasing any products described or contained herein for an above-mentioned use shall:
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